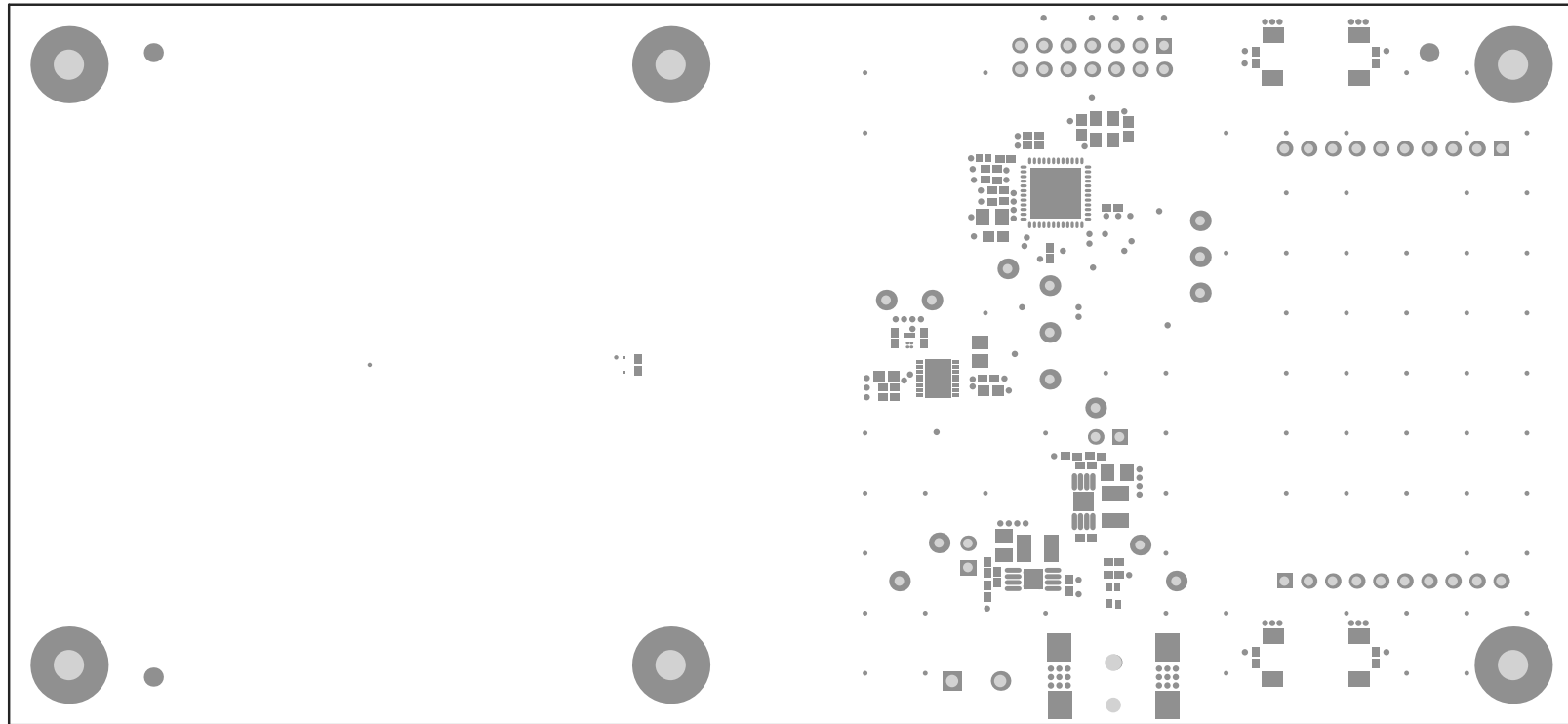
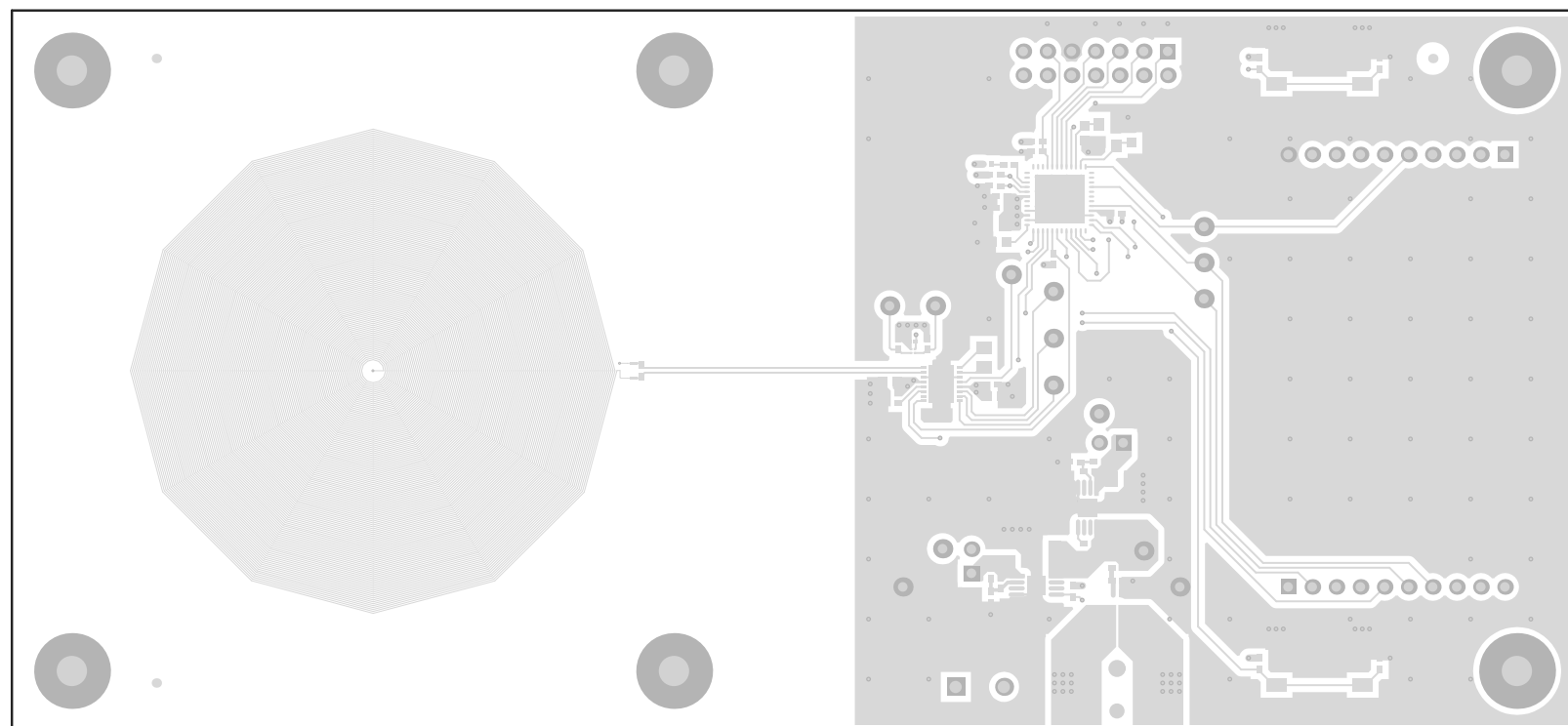


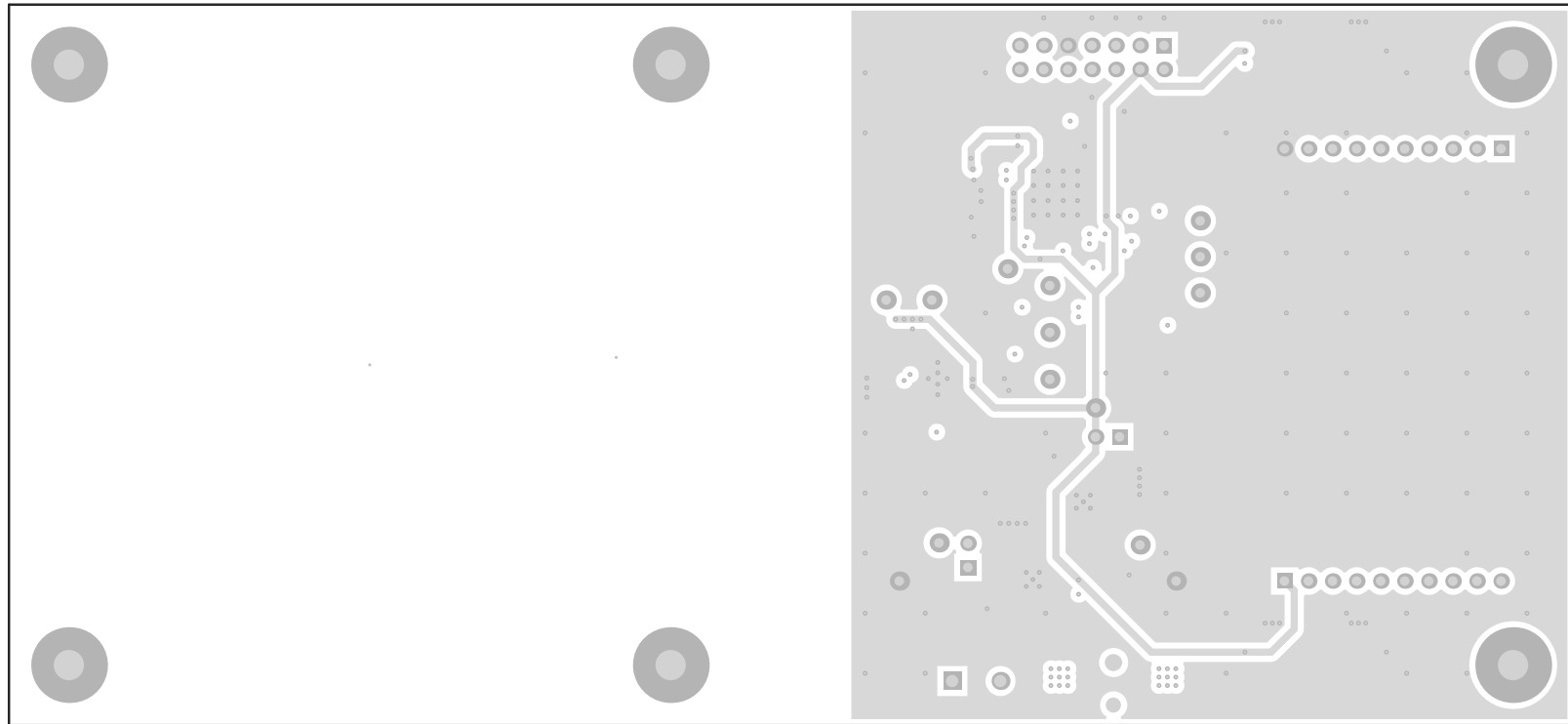
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 6/11/2014 10:14:52 AM	TEXAS INSTRUMENTS	



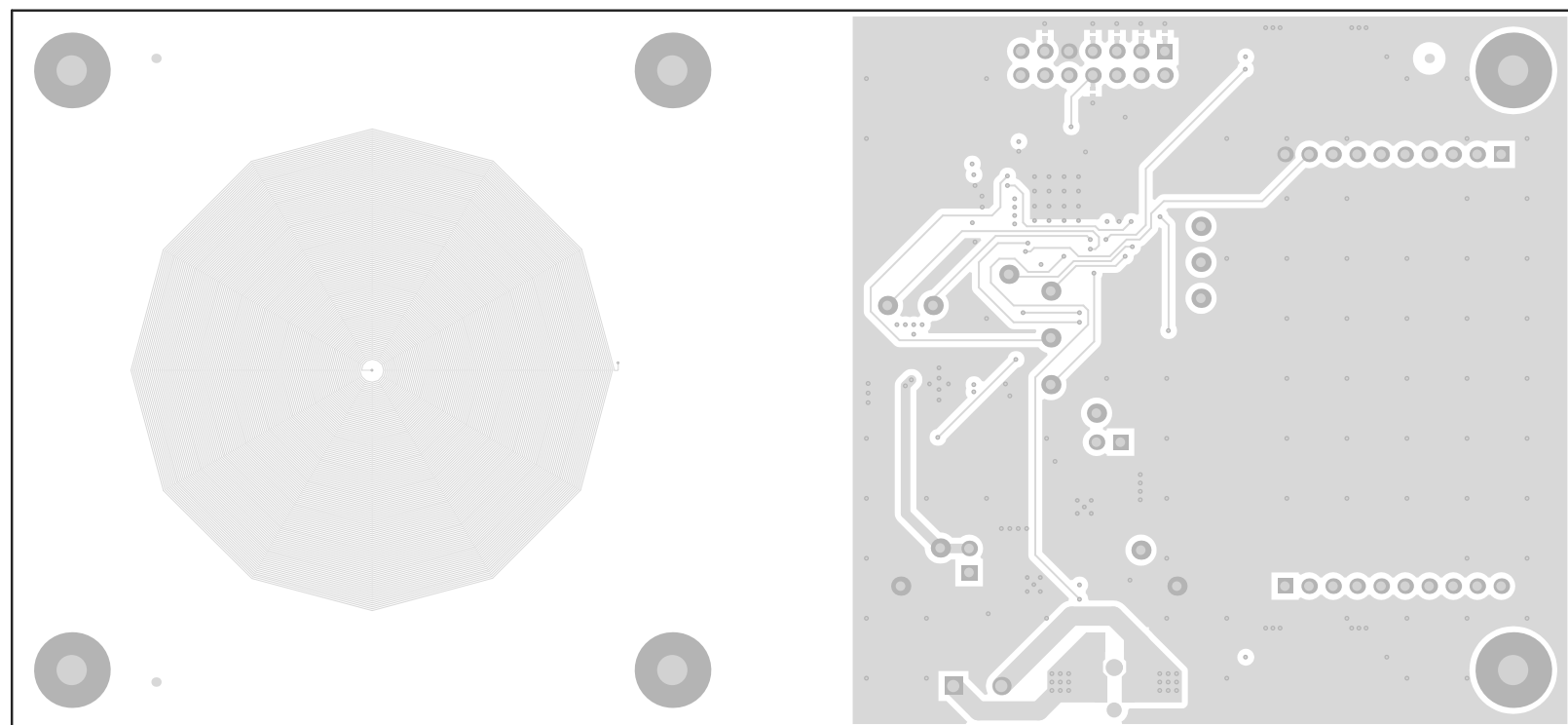
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 6/11/2014 10:14:53 AM	TEXAS INSTRUMENTS	



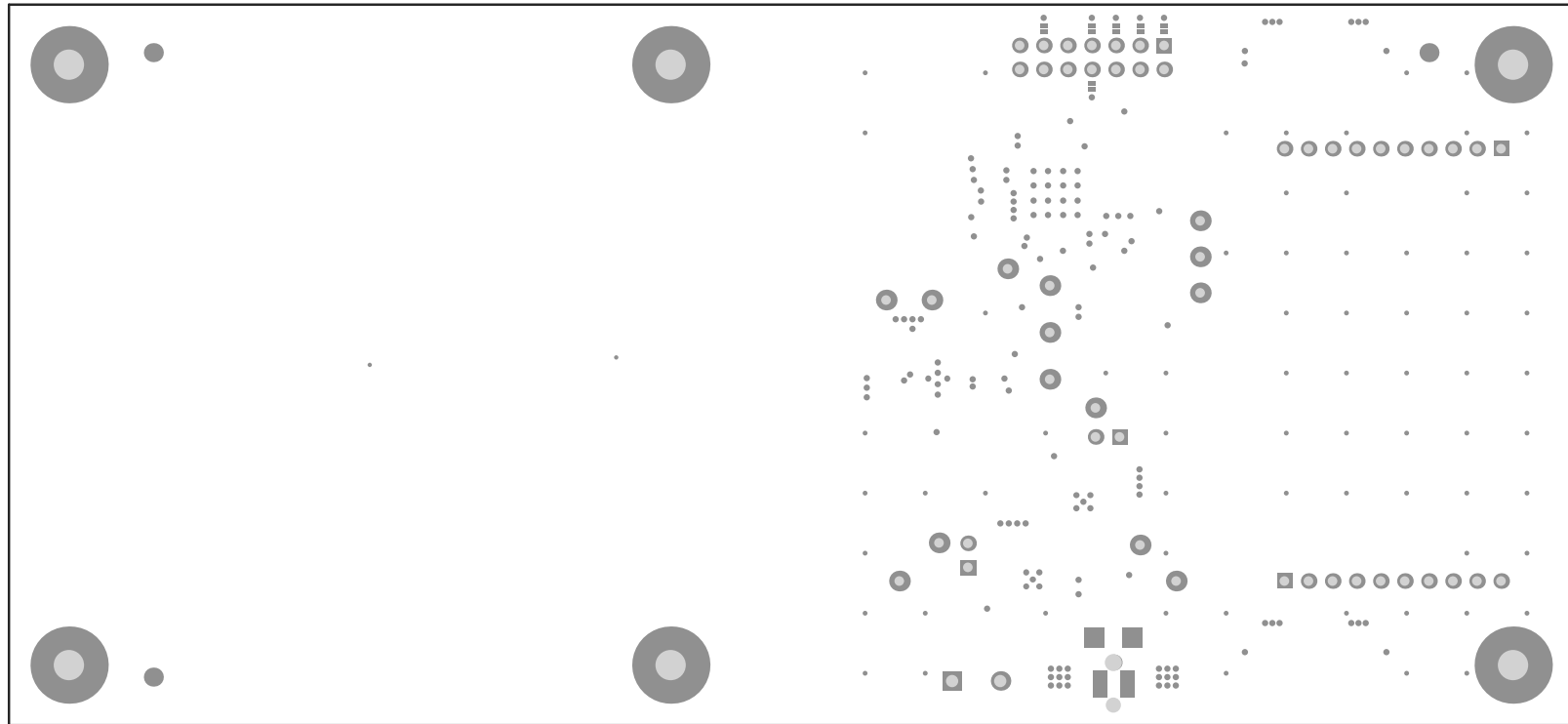
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 -Top Layer			
PLOT NAME = Top Layer	GENERATED : 6/11/2014 10:14:53 AM	TEXAS INSTRUMENTS	



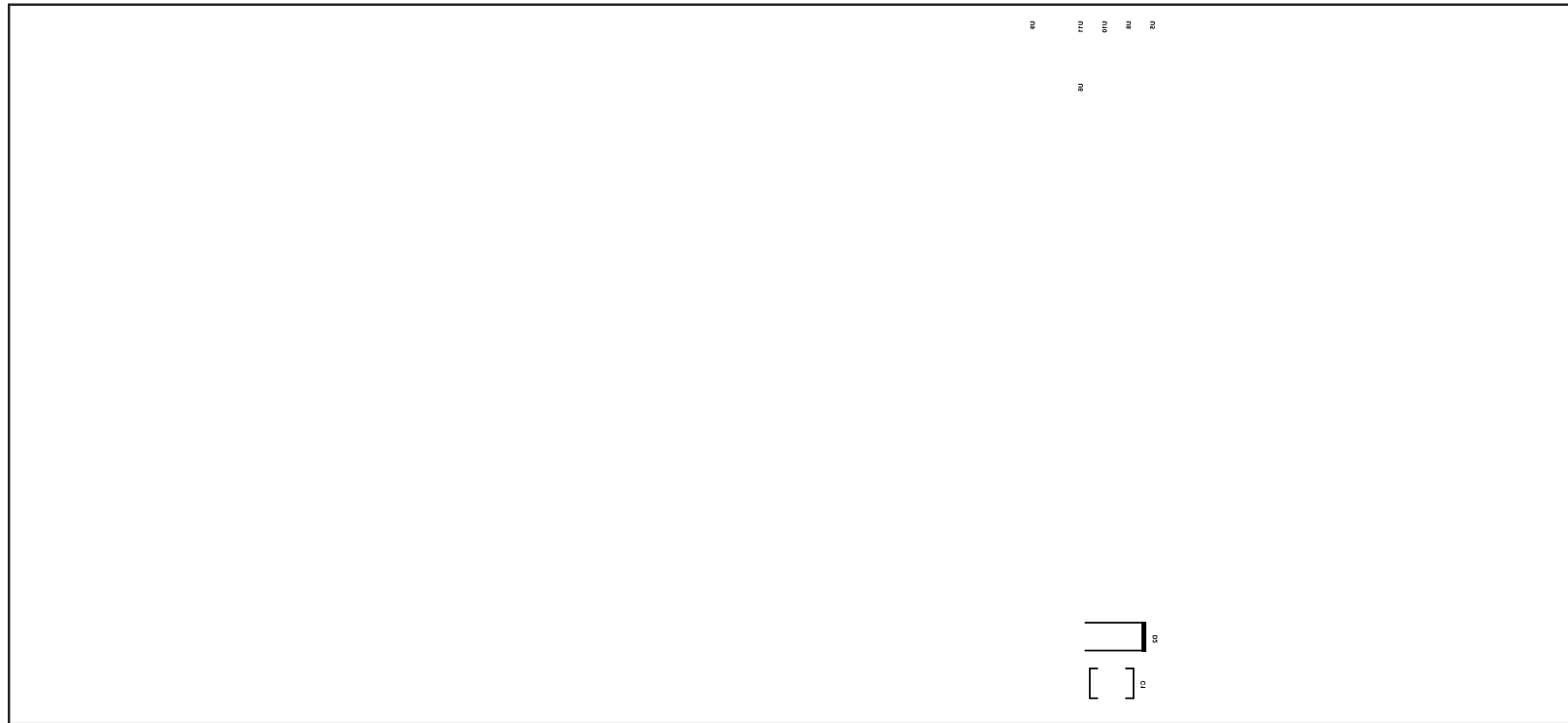
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - Power			
PLOT NAME = MidLayer1	GENERATED : 6/11/2014 10:14:54 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 -Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 6/11/2014 10:14:55 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 6/11/2014 10:14:55 AM	TEXAS INSTRUMENTS	



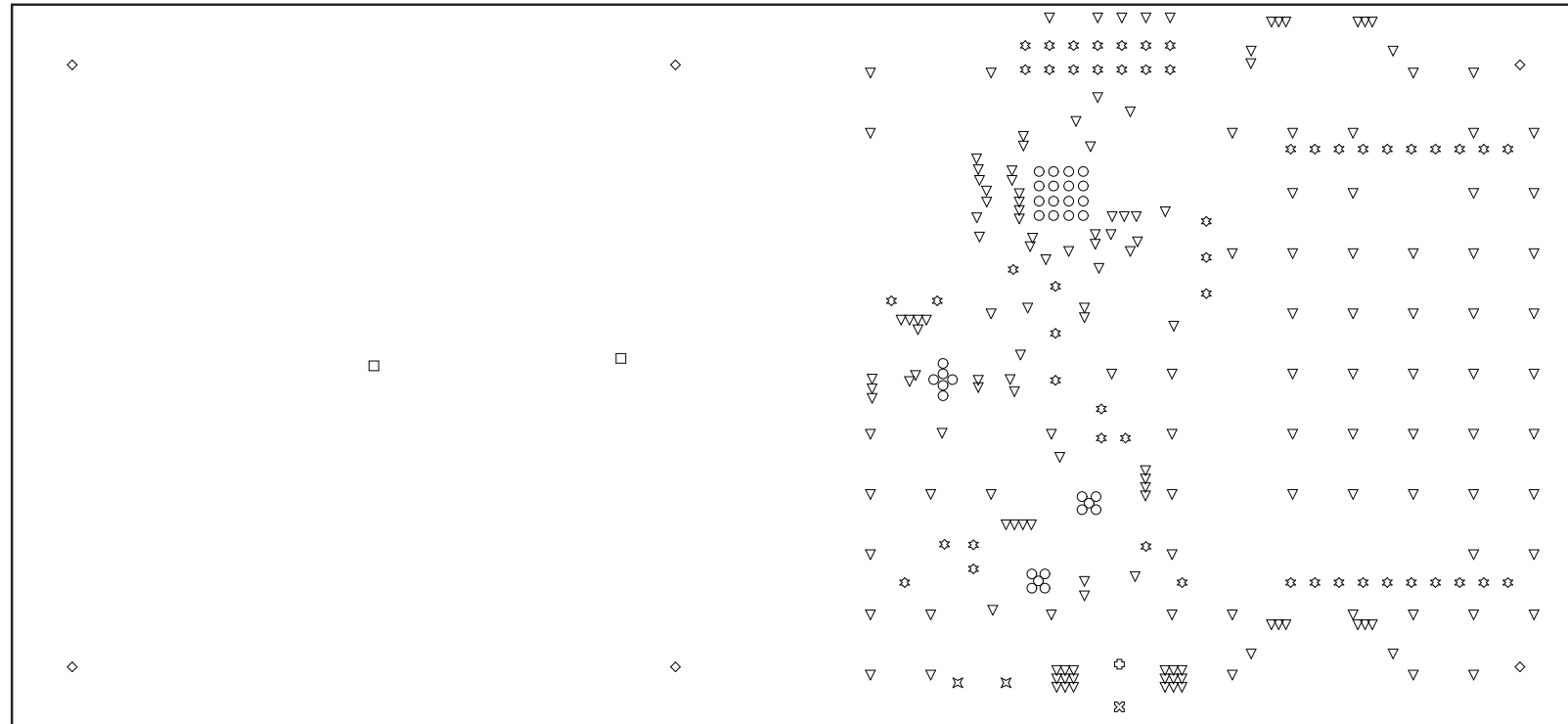
0 1 2 3 4 5 6 7 8 9

0

0

0

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 6/11/2014 10:14:56 AM	TEXAS INSTRUMENTS	

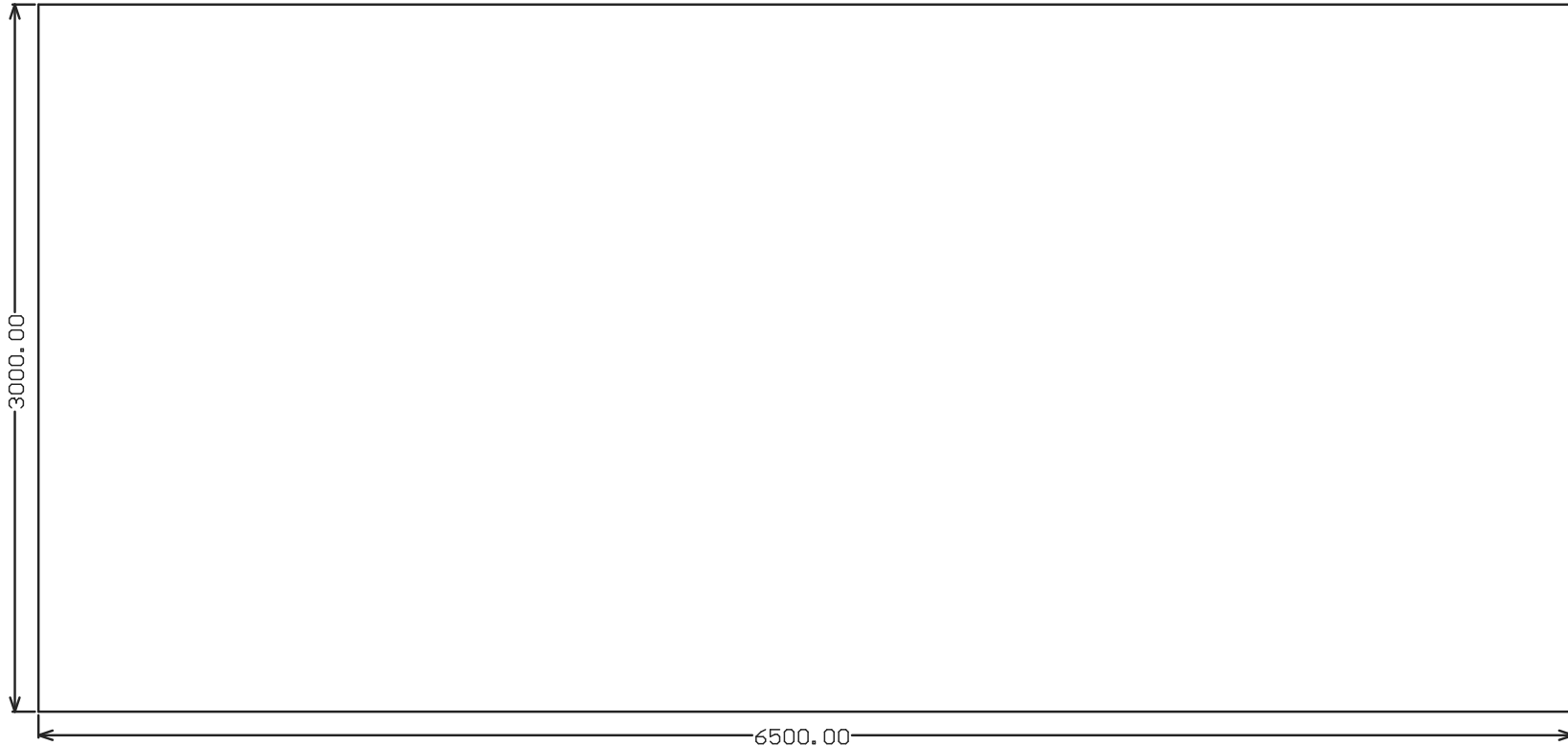


Symbol	Hit Count	Tool Size	Plated	Hole Type
□	2	6mil (0.152mm)	PTH	Round
○	32	7.874mil (0.2mm)	PTH	Round
▽	174	10mil (0.254mm)	PTH	Round
*	52	40mil (1.016mm)	PTH	Round
⊗	2	51.181mil (1.3mm)	PTH	Round
⊗	1	62.992mil (1.6mm)	NPTH	Round
⊗	1	70.866mil (1.8mm)	NPTH	Round
◇	6	125.984mil (3.2mm)	PTH	Round
	270 Total			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 6/11/2014 10:14:56 AM	TEXAS INSTRUMENTS	





ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4008	REV: E2	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 6/11/2014 10:14:57 AM	TEXAS INSTRUMENTS	

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